

#### **SCAN18373T**

# **Transparent Latch with TRI-STATE® Outputs**

#### **General Description**

The SCAN18373T is a high speed, low-power transparent latch featuring separate data inputs organized into dual 9-bit bytes with byte-oriented latch enable and output enable control signals. This device is compliant with IEEE 1149.1 Standard Test Access Port and Boundary Scan Architecture with the incorporation of the defined boundary-scan test logic and test access port consisting of Test Data Input (TDI), Test Data Out (TDO), Test Mode Select (TMS), and Test Clock

#### **Features**

- IEEE 1149.1 (JTAG) Compliant
- Buffered active-low latch enable
- TRI-STATE outputs for bus-oriented applications
- 9-bit data busses for parity applications
- Reduced-swing outputs source 24 mA/sink 48 mA
- Guaranteed to drive 50Ω transmission line to TTL input levels of 0.8V and 2.0V
- TTL compatible inputs
- 25 mil pitch Cerpack packaging
- Includes CLAMP and HIGHZ instructions
- Standard Microcircuit Drawing (SMD) 5962-9311801

#### **Connection Diagram**

	_			•
TMS —	1	$\cup$	56	<b>—</b> ты
AO <sub>0</sub> —	2		55	— Alo
AOE <sub>1</sub>	3		54	— ALE
A01-	4		53	— AI <sub>1</sub>
AO <sub>2</sub> —	5		52	— AI <sub>2</sub>
GND —	6		51	— GND
A03 -	7		50	— AI3
A04 -	8		49	— AI <sub>4</sub>
v <sub>cc</sub> —	9		48	−v <sub>cc</sub>
A05 -	10		47	— AI5
A0 <sub>6</sub> —	11		46	— AI6
GND —	12		45	— GND
A0 <sub>7</sub> —	13		44	— AI7
A0 <sub>8</sub> —	14		43	— AI8
во <sub>о</sub> —	15		42	— ві <sub>о</sub>
во <sub>1</sub> —	16		41	— ВI <sub>1</sub>
GND —	17		40	— GND
во <sub>2</sub> —	18		39	<b>—</b> ві <sub>2</sub>
во <sub>3</sub> —	19		38	— ві <sub>з</sub>
v <sub>cc</sub> —	20		37	−v <sub>cc</sub>
во <sub>4</sub> —	21		36	— BI₄
во <sub>5</sub> —	22		35	— ві <sub>5</sub>
GND —	23		34	— GND
во <sub>6</sub> —	24		33	— ві <sub>6</sub>
во <sub>7</sub> —	25		32	<b>—</b> ві <sub>7</sub>
BOE <sub>1</sub> —	26		31	—BLE
во <sub>8</sub> —	27		30	— ві <sub>8</sub>
TDO —	28		29	<b>—</b> тск

Pin Names	Description
AI <sub>(0-8)</sub> , BI <sub>(0-8)</sub> ALE, BLE	Data Inputs
ALE, BLE	Latch Enable Inputs
AOE₁, BOE₁	TRI-STATE Output Enable Inputs
AO <sub>(0-8)</sub> , BO <sub>(0-8)</sub>	TRI-STATE Latch Outputs

#### **Truth Tables**

	AO (0-8)		
ALE	AOE <sub>1</sub>	AI (0-8)	
Х	Н	Х	Z
Н	L	L	L
Н	L	Н	Н
L	L	X	AOo

	Inputs				
BLE	BOE <sub>1</sub>	BI (0-8)			
Х	Н	X	Z		
Н	L	L	L		
Н	L	Н	н		
L	L	X	BOo		

H= HIGH Voltage Level

#### **Functional Description**

The SCAN18373T consists of two sets of nine D-type latches with TRI-STATE standard outputs. When the Latch Enable (ALE or BLE) input is HIGH, data on the inputs  $(AI_{(0-8)} \text{ or } BI_{(0-8)})$  enters the latches. In this condition the latches are transparent, i.e., a latch output will change state each time its input changes. When Latch Enable is LOW, the latches store the information that was present on the inputs a set-up time preceding the HIGH-to-LOW transition of the

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L= LOW Voltage Level

X= Immaterial

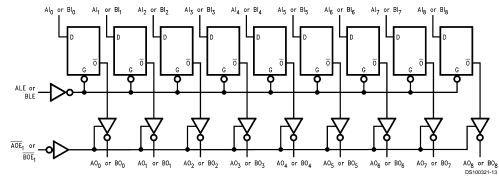
Z= High Impedance AO<sub>0</sub> = Previous AO before H-to-L transition of ALE BO<sub>0</sub> = Previous BO before H-to-L transition of BLE

# Functional Description (Continued)

Latch Enable. The TRI-STATE standard outputs are controlled by the Output Enable  $(\overline{AOE}_1^-)$  or  $\overline{BOE}_1^-)$  input. When Output Enable is LOW, the standard outputs are in the

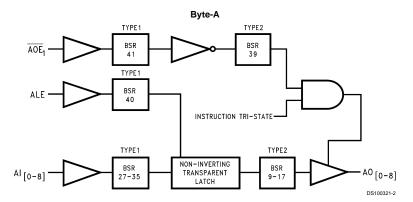
2-state mode. When Output Enable is HIGH, the standard outputs are in the high impedance mode, but this does not interfere with entering new data into the latches.

#### **Logic Diagram**

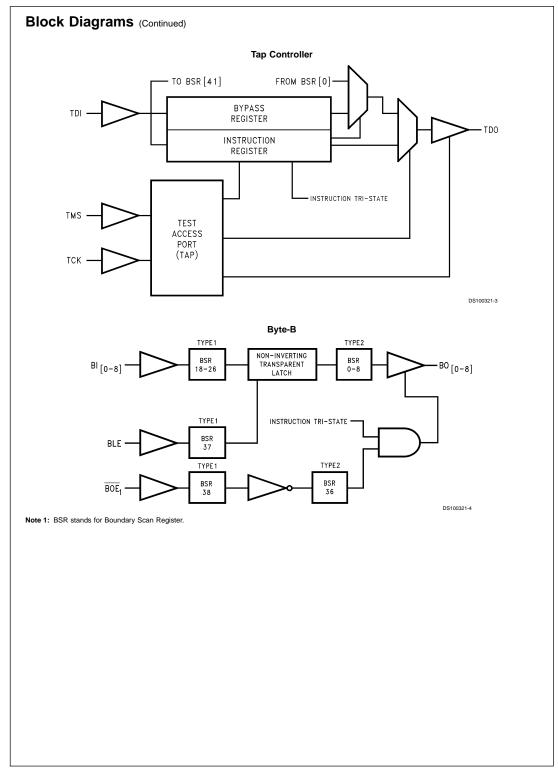


Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

## **Block Diagrams**



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## **Description of Boundary-Scan Circuitry**

The scan cells used in the BOUNDARY-SCAN register are one of the following two types depending upon their location. Scan cell TYPE1 is intended to solely observe system data, while TYPE2 has the additional ability to control system data. (See IEEE Standard 1149.1 for a further description of scan cell TYPE1 and for a further description of scan cell TYPE2.)

Scan cell TYPE1 is located on each system input pin while scan cell TYPE2 is located at each system output pin as well as at each of the two internal active-high output enable signals. AOE controls the activity of the A-outputs while BOE controls the activity of the B-outputs. Each will activate their respective outputs by loading a logic high.

The BYPASS register is a single bit shift register stage identical to scan cell TYPE1. It captures a fixed logic low.

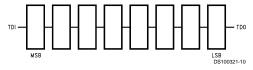
#### Bypass Register Scan Chain Definition Logic 0



The INSTRUCTION register is an eight-bit register which captures the value 00111101.

The two least significant bits of this captured value (01) are required by IEEE Std 1149.1. The upper six bits are unique to the SCAN18373T device. SCAN CMOS Test Access Logic devices do not include the IEEE 1149.1 optional identification register. Therefore, this unique captured value can be used as a "pseudo ID" code to confirm that the correct device is placed in the appropriate location in the boundary scan chain

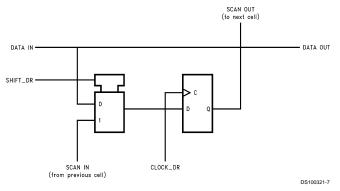
#### Instruction Register Scan Chain Definition

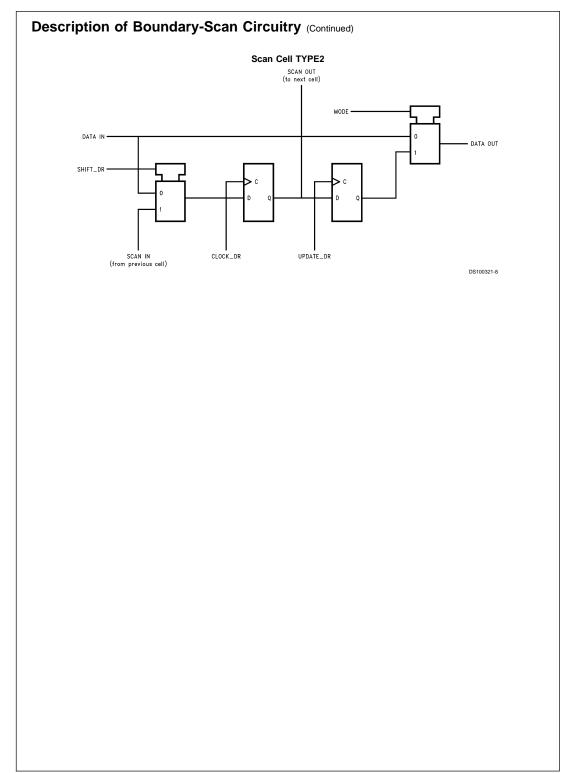


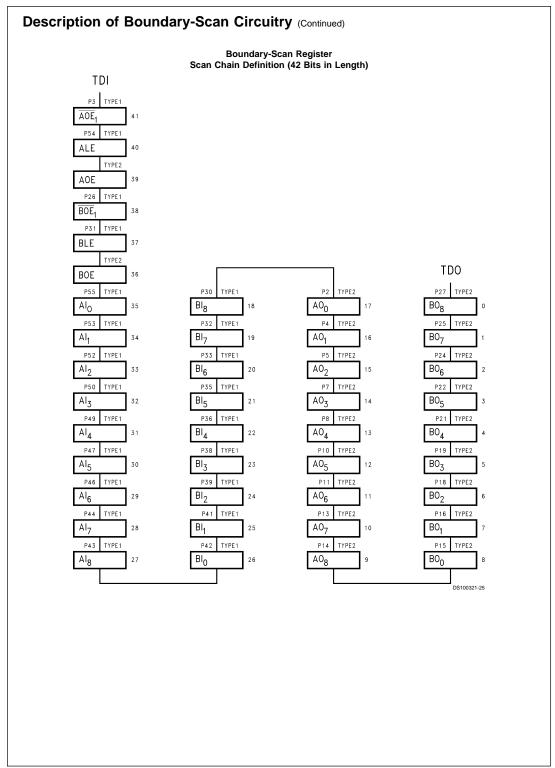
#### $MSB \rightarrow LSB$

Instruction Code	Instruction
00000000	EXTEST
10000001	SAMPLE/PRELOAD
10000010	CLAMP
00000011	HIGHZ
All Others	BYPASS

#### Scan Cell TYPE1







# $\textbf{Description of Boundary-Scan Circuitry} \ \, \textbf{(Continued)}$

# **Boundary-Scan Register Definition Index**

Bit No.	Pin Name	Pin No.	Pin Type	Scan Cell	Туре
41	AOE <sub>1</sub>	3	Input	TYPE1	Control
40	ACP	54	Input	TYPE1	Signals
39	AOE		Internal	TYPE2	
38	BOE <sub>1</sub>	26	Input	TYPE1	
37	BCP	31	Input	TYPE1	
36	BOE		Internal	TYPE2	
35	Al <sub>0</sub>	55	Input	TYPE1	A-in
34	Al <sub>1</sub>	53	Input	TYPE1	
33	$Al_2$	52	Input	TYPE1	
32	$Al_3$	50	Input	TYPE1	
31	$Al_4$	49	Input	TYPE1	
30	Al <sub>5</sub>	47	Input	TYPE1	
29	$AI_6$	46	Input	TYPE1	
28	Al <sub>7</sub>	44	Input	TYPE1	
27	Al <sub>8</sub>	43	Input	TYPE1	
26	Blo	42	Input	TYPE1	B-in
25	BI₁	41	Input	TYPE1	
24	$Bl_2$	39	Input	TYPE1	
23	$Bl_3$	38	Input	TYPE1	
22	$Bl_4$	36	Input	TYPE1	
21	BI <sub>5</sub>	35	Input	TYPE1	
20	BI <sub>6</sub>	33	Input	TYPE1	
19	BI <sub>7</sub>	32	Input	TYPE1	
18	BI <sub>8</sub>	30	Input	TYPE1	
17	$AO_0$	2	Output	TYPE2	A-out
16	AO <sub>1</sub>	4	Output	TYPE2	
15	AO <sub>2</sub>	5	Output	TYPE2	
14	$AO_3$	7	Output	TYPE2	
13	AO <sub>4</sub>	8	Output	TYPE2	
12	AO <sub>5</sub>	10	Output	TYPE2	
11	AO <sub>6</sub>	11	Output	TYPE2	
10	AO <sub>7</sub>	13	Output	TYPE2	
9	AO <sub>8</sub>	14	Output	TYPE2	
8	BO <sub>0</sub>	15	Output	TYPE2	B-out
7	BO <sub>1</sub>	16	Output	TYPE2	
6	BO <sub>2</sub>	18	Output	TYPE2	
5	BO <sub>3</sub>	19	Output	TYPE2	
4	BO <sub>4</sub>	21	Output	TYPE2	
3	BO <sub>5</sub>	22	Output	TYPE2	
2	BO <sub>6</sub>	24	Output	TYPE2	
1	BO <sub>7</sub>	25	Output	TYPE2	
0	BO <sub>8</sub>	27	Output	TYPE2	

## Absolute Maximum Ratings (Note 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage (V<sub>CC</sub>) -0.5V to +7.0VDC Input Diode Current ( $I_{IK}$ )  $V_1 = -0.5V$ -20 mA  $V_I = V_{CC} + 0.5V$ +20 mA DC Output Diode Current (I<sub>OK</sub>)  $V_{\rm O} = -0.5 V$ -20 mA  $V_O = V_{CC} + 0.5V$ +20 mA DC Output Voltage (V<sub>O</sub>) –0.5V to  $V_{\rm CC}$  + 0.5V DC Output Source/Sink Current  $(I_O)$ ±70 mA DC  $V_{\rm CC}$  or Ground Current Per Output Pin ±70 mA

Junction Temperature Cerpack +175°C -65°C to +150°C Storage Temperature

ESD (Min) 2000V

#### **Recommended Operating Conditions**

Supply Voltage ( $V_{CC}$ ) SCAN Products 4.5V to 5.5V 0V to V<sub>CC</sub> Input Voltage (V<sub>I</sub>) 0V to  $V_{\rm CC}$ Output Voltage (V<sub>O</sub>)

Operating Temperature (T<sub>A</sub>)

Military -55°C to +125°C Minimum Input Edge Rate dV/dt 125 mV/ns

 $V_{\text{IN}}$  from 0.8V to 2.0V V<sub>CC</sub> @ 4.5V, 5.5V

Note 2: Absolute maximum ratings are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. National does not recommend operation of SCAN circuits outside databook specifications.

#### **DC Electrical Characteristics**

			Military		
Cumahad	Parameter	V <sub>cc</sub>	T <sub>A</sub> =		
Symbol	Parameter	(V)	-55°C to +125°C	Units	Conditions
			Guaranteed Limits		
V <sub>IH</sub>	Minimum High	4.5	2.0	V	V <sub>OUT</sub> = 0.1V
	Input Voltage	5.5	2.0		or V <sub>CC</sub> – 0.1V
V <sub>IL</sub>	Maximum Low	4.5	0.8	V	V <sub>OUT</sub> = 0.1V
	Input Voltage	5.5	0.8		or V <sub>CC</sub> – 0.1V
V <sub>OH</sub>	Minimum High	4.5	3.15	V	I <sub>OUT</sub> = -50 μA
	Output Voltage	5.5	4.15		
		4.5	2.4	V	$V_{IN} = V_{IL} \text{ or } V_{IH}$
		5.5	2.4		I <sub>OH</sub> = -24 mA
V <sub>OL</sub>	Maximum Low	4.5	0.1	V	I <sub>OUT</sub> = 50 μA
	Output Voltage	5.5	0.1		
		4.5	0.55	V	V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub>
		5.5	0.55		I <sub>OL</sub> = 48 mA
I <sub>IN</sub>	Maximum Input	5.5	±1.0	μA	V <sub>I</sub> = V <sub>CC</sub> , GND
	Leakage Current				
I <sub>IN</sub>	Maximum Input	5.5	3.7	μA	V <sub>I</sub> = V <sub>CC</sub>
TDI, TMS	Leakage		-385	μA	V <sub>I</sub> = GND
	Minimum Input Leakage	5.5	-160	μA	V <sub>I</sub> = GND
I <sub>OLD</sub>	(Note 3) Minimum	5.5	63	mA	V <sub>OLD</sub> = 0.8V Ma
I <sub>OHD</sub>	Dynamic Output Current		-27	mA	V <sub>OHD</sub> = 2.0V Min
l <sub>oz</sub>	Maximum Output Leakage Current	5.5	±10.0	μА	$V_{I}$ (OE) = $V_{IL}$ , $V_{I}$
I <sub>os</sub>	Output Short Circuit	5.5	-100	mA	V <sub>O</sub> = 0V
	Current			Min	
I <sub>cc</sub>	Maximum Quiescent	5.5	168	μA	V <sub>O</sub> = Open
	Supply Current				TDI, TMS = V <sub>CC</sub>
		5.5	930	μA	V <sub>O</sub> = Open
					TDI, TMS = GNI

#### DC Electrical Characteristics (Continued)

Symbol	Parameter	V <sub>cc</sub> (V)	Military  T <sub>A</sub> =  -55°C to +125°C  Guaranteed Limits	Units	Conditions
I <sub>CCt</sub>	Maximum I <sub>CC</sub> per Input	5.5	2.0	mA	$V_{I} = V_{CC} - 2.1V$
		5.5	2.15	mA	V <sub>I</sub> = V <sub>CC</sub> - 2.1V TDI/TMS Pin, Test One with the Other Floating

Note 3: Maximum test duration 2.0 ms, one output loaded at a time.

Note 4: All outputs loaded; thresholds associated with output under test.

Note 5: Maximum test duration 2.0 ms, one output loaded at a time.

## **Noise Specifications**

		V <sub>cc</sub>	Military		Fig.
Symbol	Parameter	(V)	T <sub>A</sub> = -55°C to +125°C	Units	No.
			Guaranteed Limits		
V <sub>OLP</sub>	Maximum High		0.8		
	Output Noise	5.0		V	
	(Notes 6, 7)				
V <sub>OLV</sub>	Minimum Low		-0.8		
	Output Noise	5.0		V	
	(Notes 6, 7)				

Note 6: Maximum number of outputs that can switch simultaneously is n. (n-1) outputs are switched LOW and one output held LOW.

Note 7: Maximum number of outputs that can switch simultaneously is n. (n-1) outputs are switched HIGH and one output held HIGH.

#### **AC Electrical Characteristics**

Normal Operation

Symbol			Mili	tary		
	Parameter	V <sub>CC</sub> (V) (Note 8)	T <sub>A</sub> =-55°C to +125°C C <sub>L</sub> = 50 pF		Units	Fig. No.
		, ,	Min	Max		
t <sub>PLH</sub> ,	Propagation	5.0	2.5	11.0	ns	
t <sub>PHL</sub>	Delay, D to Q		2.5	11.5		
t <sub>PLH</sub> ,	Propagation	5.0	2.5	12.0	ns	
t <sub>PHL</sub>	Delay, LE to Q		2.5	13.0		
t <sub>PLZ</sub> ,	Disable Time	5.0	1.5	11.0	ns	
t <sub>PHZ</sub>			1.5	10.3		
t <sub>PZL</sub> ,	Enable Time	5.0	2.0	13.5	ns	
t <sub>PZH</sub>			2.0	11.5		

Note 8: Voltage Range 5.0 is 5.0V ±0.5V.

# **AC Operating Requirements**

Normal Operation

		.,	Military		
Symbol	Parameter	V <sub>cc</sub> (V)	T <sub>A</sub> = -55°C to +125°C	Units	Fig. No.
	1 4141110101	(Note 9)	C <sub>L</sub> = 50 pF	••	No.
			Guaranteed Minimum		
t <sub>S</sub>	Setup Time, H or L	5.0	3.0	ns	
			-		

# AC Operating Requirements (Continued)

Normal Operation

Symbol	Parameter	V <sub>CC</sub> (V) (Note 9)	Military  T <sub>A</sub> = -55°C to +125°C  C <sub>L</sub> = 50 pF  Guaranteed Minimum	Units	Fig. No.
	Data to LE				
t <sub>H</sub>	Hold Time, H or L	5.0	1.5	ns	
	LE to Data				
t <sub>W</sub>	LE Pulse Width	5.0	5.0	ns	

Note 9: Voltage Range 5.0 is 5.0V ±0.5V.

## **AC Electrical Characteristics**

Scan Test Operation

		V <sub>cc</sub>	Mili	Units	Fig. No.	
Symbol	Parameter	(V)	T <sub>A</sub> =-55°C to +125°C C <sub>L</sub> = 50 pF			
		(Note 10)	Min	Max	_	NO.
t <sub>PLH</sub> ,	Propagation Delay	5.0	3.5	15.8	ns	
t <sub>PHL</sub>	TCK to TDO		3.5	15.8		
t <sub>PLZ</sub> ,	Disable Time	5.0	2.5	12.8	ns	
t <sub>PHZ</sub>	TCK to TDO		2.5	12.8		
t <sub>PZL</sub> ,	Enable Time	5.0	3.0	16.7	ns	
t <sub>PZH</sub>	TCK to TDO		3.0	16.7		
t <sub>PLH</sub> ,	Propagation Delay		5.0	21.7		
t <sub>PHL</sub>	TCK to Data Out		5.0	21.7	ns	
1112	during Update-DR State	5.0				
t <sub>PLH</sub> ,	Propagation Delay		5.0	22.0		
t <sub>PHL</sub>	TCK to Data Out during Update-IR State	5.0	5.0	22.0	ns	
t <sub>PLH</sub> ,	Propagation Delay		5.5	23.0		
t <sub>PHL</sub>	TCK to Data Out				ns	
1112	during Test Logic Reset State	5.0	5.5	23.0		
t <sub>PLZ</sub> ,	Propagation Delay		4.0	19.6		
t <sub>PHZ</sub>	TCK to Data Out		4.0	19.6	ns	
1112	during Update-DR State	5.0				
t <sub>PLZ</sub> ,	Propagation Delay		5.0	22.4		
t <sub>PHZ</sub>	TCK to Data Out	5.0	5.0	22.4	ns	
	during Update-IR State					
t <sub>PLZ</sub> ,	Propagation Delay		5.0	23.3		
t <sub>PHZ</sub>	TCK to Data Out	5.0			ns	
	during Test Logic		5.0	23.3		
	Reset State					
t <sub>PZL</sub> ,	Propagation Delay		5.0	22.6		
t <sub>PZH</sub>	TCK to Data Out during Update-DR State	5.0	5.0	22.6	ns	

# AC Electrical Characteristics (Continued)

Scan Test Operation

.

Symbol	Parameter	V <sub>CC</sub> (V) (Note 10)	Military  T <sub>A</sub> =-55°C to +125°C  C <sub>L</sub> = 50 pF		Units	Fig. No.
		(11010-10)	Min	Max		
t <sub>PZL</sub> ,	Propagation Delay		6.5	26.2		
$t_{PZH}$	TCK to Data Out	5.0	6.5	26.2	ns	
	during Update-IR State					
t <sub>PZL</sub> ,	Propagation Delay		7.0	27.4		
t <sub>PZH</sub>	TCK to Data Out	5.0			ns	
	during Test Logic		7.0	27.4		
	Reset State					

Note 10: Voltage Range 5.0 is 5.0V ±0.5V.

All propagation delays involving TCK are measured from the falling edge of TCK.

# AC Operating Requirements Scan Test Operation

Symbol	Parameter	V <sub>CC</sub> (V) (Note 11)	Military $T_A = -55^{\circ}C \text{ to } +125^{\circ}C$ $C_L = 50 \text{ pF}$ Guaranteed Minimum	Units	Fig. No.
t <sub>S</sub>	Setup Time,	5.0	3.0	ns	
	Data to TCK (Note 13)				
t <sub>H</sub>	Hold Time,	5.0	5.5	ns	
	TCK to Data (Note 13)				
t <sub>S</sub>	Setup Time, H or L	5.0	3.0	ns	
	AOE₁, BOE₁ to TCK (Note 15)				
t <sub>H</sub>	Hold Time, H or L	5.0	4.5	ns	
	TCK to $\overline{AOE}_1$ , $\overline{BOE}_1$ (Note 15)				
t <sub>S</sub>	Setup Time, H or L				
	Internal AOE, BOE,	5.0	3.0	ns	
	to TCK (Note 14)				
t <sub>H</sub>	Hold Time, H or L				
	TCK to Internal	5.0	3.0	ns	
	AOE, BOE (Note 14)				
t <sub>S</sub>	Setup Time	5.0	3.0	ns	
	ALE, BLE (Note 12) to TCK				
t <sub>H</sub>	Hold Time	5.0	4.0	ns	
	TCK to ALE, BLE (Note 12)				
t <sub>S</sub>	Setup Time, H or L	5.0	8.0	ns	
Ü	TMS to TCK				
t <sub>H</sub>	Hold Time, H or L	5.0	2.0	ns	
	TCK to TMS				
t <sub>S</sub>	Setup Time, H or L	5.0	4.0	ns	
-5	TDI to TCK				
t <sub>H</sub>	Hold Time, H or L	5.0	4.5	ns	
	TCK to TDI				
t <sub>W</sub>	Pulse Width TCK	5.0			
••	н		12.0	ns	
	 L		5.0		
f <sub>max</sub>	Maximum TCK	5.0	25	MHz	
шах	Clock Frequency				

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# AC Operating Requirements (Continued)

Scan Test Operation

Symbol	Parameter	V <sub>CC</sub> (V) (Note 11)	Military  T <sub>A</sub> = -55°C to +125°C  C <sub>L</sub> = 50 pF  Guaranteed Minimum	Units	Fig. No.	
T <sub>pu</sub>	Wait Time, Power Up to TCK	5.0	100	ns		
T <sub>dn</sub>	Power Down Delay	0.0	100	ms		

Note 11: Voltage Range 5.0 is 5.0V  $\pm 0.5$ V.

All Input Timing Delays involving TCK are measured from the rising edge of TCK.

Note 12: Timing pertains to BSR 37 and 40 only.

Note 13: This delay represents the timing relationship between the data input and TCK at the associated scan cells numbered 0-8, 9-17, 18-26 and 27-35.

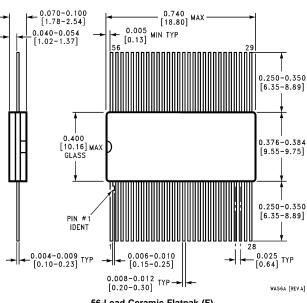
Note 14: This delay represents the timing relationship between AOE/BOE and TCK for scan cells 36 and 39 only.

Note 15: Timing pertains to BSR 38 and 41 only.

# Capacitance

Symbol	Parameter	Max	Units	Conditions
C <sub>IN</sub>	Input Pin Capacitance	5.0	pF	$V_{\rm CC} = 5.0 V$
C <sub>OUT</sub>	Output Pin Capacitance	15.0	pF	V <sub>CC</sub> = 5.0V
C <sub>PD</sub>	Power Dissipation Capacitance	35.0	pF	$V_{CC} = 5.0V$

#### Physical Dimensions inches (millimeters) unless otherwise noted



56-Lead Ceramic Flatpak (F) NS Package Number WA56A

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- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.



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